

Dual Mode 5V/Programmable Micropower Voltage Regulators

ABSOLUTE MAXIMUM RATINGS

MAX663 and MAX666

Input Supply Voltage	+18V
Terminal Voltage	
Pins 1,3,5,6, MAX663 — Pin 7, and MAX666 — Pin 2,	GND -0.3V to $V_{IN} + 0.3V$
MAX663 — Pin 2	GND -0.3V to $V_{OUT1} + 0.3V$
MAX666 — Pin 7	GND -0.3V to +16.5V
Output Source Current	
MAX663,666 — Pin 2 (V_{OUT2} , V_{OUT})	50mA
MAX663 — Pin 3 (V_{OUT1})	25mA
Output Sink Current, Pin 7	-20mA

ALL DEVICES

Power Dissipation	
Plastic DIP (Derate 8.3mW/°C above +50°C)	625mW
Small Outline (Derate 6mW/°C above +50°C)	450mW
CERDIP (Derate 8mW/°C above +50°C)	800mW
Operating Temperature Range	
MAX66XC	0°C to +70°C
MAX66XE	-40°C to +85°C
MAX66XM	-55°C to +125°C
Storage Temperature	-65°C to +150°C
Lead Temperature (Soldering 10 seconds)	+300°C

MAX664

Input Supply Voltage	-18V
Terminal Voltage	
Pins 1,3,5,6,7	$V_{IN} - 0.3V$ to GND +0.3V
Pin 2	$V_{IN} - 0.3V$ to $V_{OUT1} + 0.3V$
Output Sink Current, (Pins 1,7)	-25mA

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS, MAX663 AND MAX666

($V_{IN} = +9V$, $V_{OUT} = +5V$, $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Voltage	V_{IN}	Over Temperature (C) Over Temperature (E, M)	2.0 2.2		16.5	V
Quiescent Current	I_Q	No Load, $V_{IN} = +16.5V$ $T_A = +25^\circ C$ Over Temperature (C) Over Temperature (E, M)		6	12 15 20	μA
Output Voltage	V_{OUT}	$V_{SET} = GND$ Over Temperature (C, E) Over Temperature (M)	4.75 4.5	5.0 5.0	5.25 5.5	V
Line Regulation	$\Delta V_{OUT}/\Delta V_{IN}$	$+2V \leq V_{IN} \leq +15V$, $V_{OUT} = V_{REF}$		0.03	0.35	%/V
Load Regulation	$\Delta V_{OUT}/\Delta I_{OUT}$	MAX663: $1mA \leq I_{OUT2} \leq 20mA$ MAX663: $50\mu A \leq I_{OUT1} \leq 5mA$ MAX666: $1mA \leq I_{OUT} \leq 20mA$		3.0 1.0 3.0	7.0 5.0 7.0	Ω
Reference Voltage	V_{SET}	$V_{OUT} = V_{SET}$	1.27		1.33	V
Reference Tempco.	$\Delta V_{SET}/\Delta T$	Over Temperature		± 100		ppm/°C
V_{SET} Internal Threshold for Fixed +5V or Adjustable Output	$V_{F/A}$	$V_{SET} < V_{F/A}$ for +5V Out $V_{SET} > V_{F/A}$ for Adjustable Out		50		mV
V_{SET} Input Current	I_{SET}	Over Temperature (C, E) Over Temperature (M)		± 0.01	± 10 ± 25	nA
Shutdown Input Voltage	V_{SHDN}	$V_{SHDN} HI =$ Output Off $V_{SHDN} LO =$ Output On	1.4		0.3	V
Shutdown Input Current	I_{SHDN}			± 0.01	± 10	nA
SENSE Input Threshold	$V_{OUT} - V_{SENSE}$	Current Limit Threshold		0.5		V
SENSE Input Resistance	R_{SENSE}			3		M Ω
Input-Output Saturation Resistance, MAX663 - V_{OUT1}	R_{SAT}	$V_{IN} = +2V$, $I_{OUT} = 1mA$ $V_{IN} = +9V$, $I_{OUT} = 2mA$ $V_{IN} = +15V$, $I_{OUT} = 5mA$		200 70 50	500 150 150	Ω
Output Current, V_{OUT2} (V_{OUT} on MAX666)	I_{OUT}	$+3V \leq V_{IN} \leq +16.5V$ $V_{IN} - V_{OUT} = +1.5V$	40			mA
Minimum Load Current	$I_{L(MIN)}$	$T_A = +25^\circ C$ Over Temperature (C, E) Over Temperature (M)			1.0 5.0 10.0	μA

Dual Mode 5V/Programmable Micropower Voltage Regulators

ELECTRICAL CHARACTERISTICS, MAX663 AND MAX666 (continued)

($V_{IN} = +9V$, $V_{OUT} = +5V$, $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LBI Input Threshold	V_{LBI}	MAX666	1.21	1.28	1.37	V
LBI Input Current	I_{LBI}	MAX666		± 0.01	± 10	nA
LBO Output Saturation Resistance	R_{SAT}	MAX666, $I_{SAT} = 2mA$		35	100	Ω
LBO Output Leakage Current		MAX666, $LBI = +1.4V$		10		nA
V_{TC} Open-Circuit Voltage (Note 1)	V_{TC}	MAX663		0.9		V
V_{TC} Sink Current (Note 1)	I_{TC}	MAX663		8.0	2.0	mA
V_{TC} Temperature Coefficient (Note 1)		MAX663		+2.5		mV/ $^\circ C$

Note 1: This output (MAX663 only) has a positive temperature coefficient. Using it in conjunction with the input of the regulator at V_{SET} , a negative coefficient results in the output voltage. The V_{TC} pin will not source current.

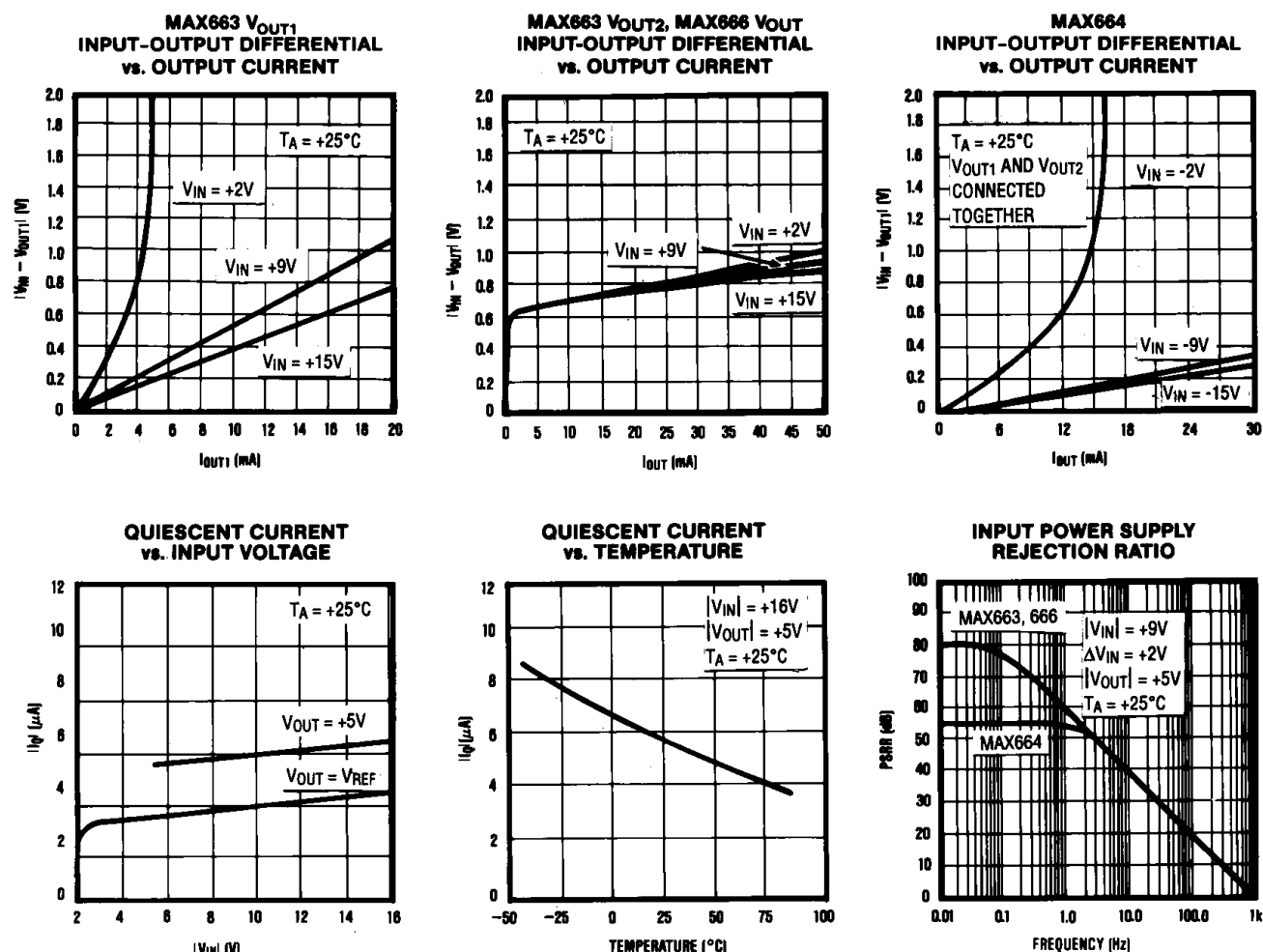
ELECTRICAL CHARACTERISTICS, MAX664

($V_{IN} = -9V$, $V_{OUT} = -5V$, $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Voltage	V_{IN}	Over Temperature (C) Over Temperature (E, M)	-2.0 -2.2		-16.5	V
Quiescent Current	I_Q	No Load, $V_{IN} = -16.5V$ $T_A = +25^\circ C$ Over Temperature (C) Over Temperature (E, M)		6	12 15 20	μA
Output Voltage	V_{OUT}	$V_{SET} = GND$ Over Temperature (C, E) Over Temperature (M)	-4.75 -4.5	-5.0 -5.0	-5.25 -5.5	V
Line Regulation	$\Delta V_{OUT} / \Delta V_{IN}$	$-2V \leq V_{IN} \leq -15V$, $V_{OUT} = V_{REF}$		0.03	0.35	%/V
Load Regulation	$\Delta V_{OUT} / \Delta I_{OUT}$	V_{OUT2} connected to V_{OUT1} , $1mA \leq I_{OUT} \leq 15mA$		2.0	5.0	Ω
Reference Voltage	V_{SET}	$V_{OUT} = V_{SET}$	-1.27		-1.33	V
Reference Tempco.	$\Delta V_{SET} / \Delta T$	Over Temperature		± 100		ppm/ $^\circ C$
V_{SET} Internal Threshold for Fixed -5V or Adjustable Output Operation	$V_{F/A}$	$V_{SET} < V_{F/A}$ for -5V Out, $V_{SET} > V_{F/A}$ for Variable Out		-50		mV
V_{SET} Input Current	I_{SET}	Over Temperature (C, E) Over Temperature (M)		± 0.01	± 10 ± 25	nA
Shutdown Input Voltage	V_{SHDN}	$V_{SHDN} HI =$ Output Off $V_{SHDN} LO =$ Output On	-1.4		-0.3	
Shutdown Input Current	I_{SHDN}			± 0.01	± 10	nA
SENSE Input Threshold	$V_{OUT} - V_{SENSE}$	Current Limit Threshold		-0.6		V
SENSE Input Resistance	R_{SENSE}			3		M Ω
Input-Output Saturation Resistance	R_{SAT}	V_{OUT2} connected to V_{OUT1} $V_{IN} = -2V$, $I_{OUT} = -1mA$ $V_{IN} = -9V$, $I_{OUT} = -2mA$ $V_{IN} = -15V$, $I_{OUT} = -5mA$		150 40 30	500 80 60	Ω
Minimum Load Current	$I_{L(MIN)}$	$T_A = +25^\circ C$ Over Temperature (C, E) Over Temperature (M)			-1.0 -5.0 -10.0	μA

Dual Mode 5V/Programmable Micropower Voltage Regulators

Typical Operating Characteristics



Pin Description

NAME	FUNCTION (See text for details)
$V_{OUT(1)(2)}$	Regulator Output(s)
V_{IN}	Regulator Input
SENSE	Current limit sense input
LBI	Low battery detection input
LBO	Low battery detection output
SHUTDOWN	Disables output for minimum power consumption
V_{SET}	Ground this pin for 5V output or Connect to external resistive divider for adjustable output
V_{TC}	Temperature-proportional voltage for negative TC output

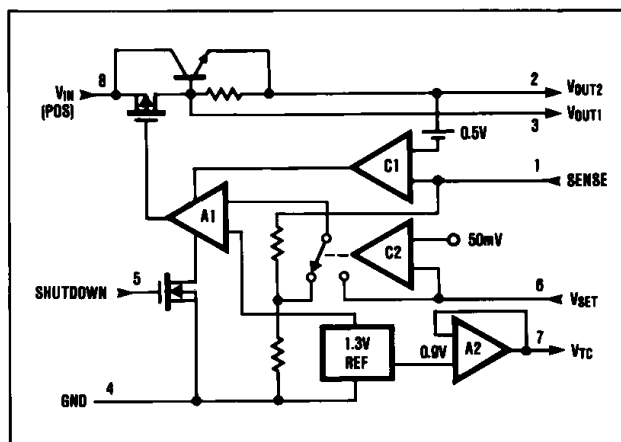


Figure 1. MAX663 Positive Regulator, Block Diagram

Dual Mode 5V/Programmable Micropower Voltage Regulators

MAX663/MAX664/MAX666

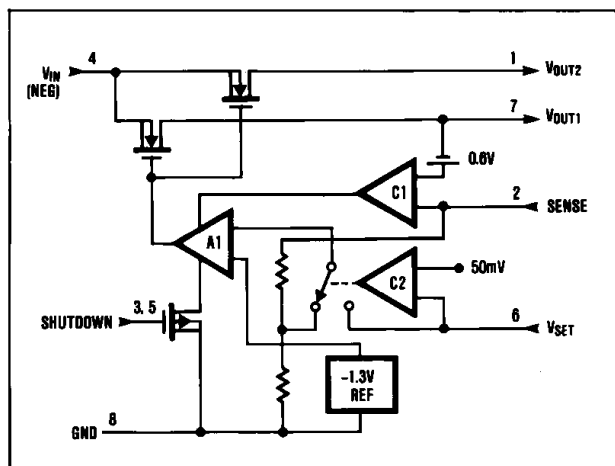


Figure 2. MAX664 Negative Regulator, Block Diagram

Detailed Description

As shown in the block diagrams for each device (Figures 1, 2, and 3), the main elements of the MAX66X family of regulators are a micropower bandgap reference, an error amplifier, and one or two series pass output devices. A P-channel FET and an NPN transistor are used on the MAX663, two N-channel FETs are used in the MAX664, and one NPN output transistor is used in the MAX666. All regulators also contain two comparators, one for current limiting (C1) and another which selects fixed 5V or adjustable output operation (C2).

The bandgap reference, which is trimmed to 1.30V $\pm$ 30mV, is internally connected to one input of the error amplifier, A1. The feedback signal from the regulator output is supplied to the A1's other input by either an on-chip voltage divider or by two external resistors. When VSET is grounded the internal divider provides the error amplifier's feedback signal for a fixed 5V output. When VSET is more than 50mV above ground (below ground for the MAX664) the error amplifier's input is switched directly to the VSET pin and external resistors set the output voltage.

Comparator C1 monitors the output current via the SENSE input and shuts down the regulator's output(s) by disabling A1. An external current sense resistor, RCL, sets the limit value. The MAX663 and MAX666 current-limit when the voltage on RCL exceeds 0.5V. The MAX664 current limits at 0.6V.

The MAX663 has an additional amplifier, A2, which provides a temperature-proportional output, VTC. When this is summed into the inverting input of the error amplifier, a negative temperature coefficient results at the output. This is useful when powering liquid crystal displays over wide temperature ranges.

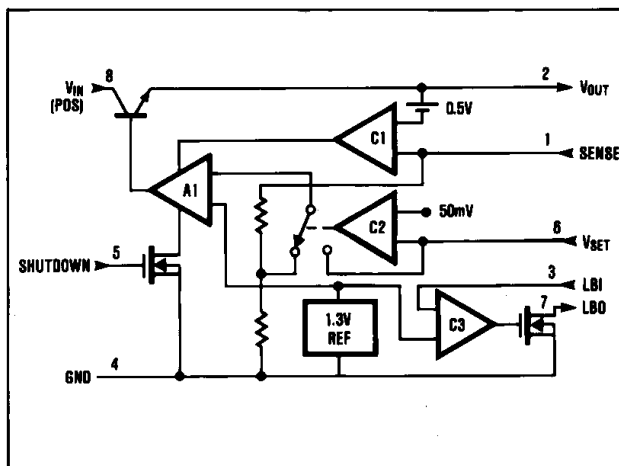


Figure 3. MAX666 Positive Regulator With Low Battery Detector, Block Diagram

The MAX666 has a third comparator, C3, which compares the LBI input to the internal 1.30V reference. The Low Battery Output, LBO, is an open drain FET connected to Ground. The Low Battery threshold can also be set with a voltage divider at LBI. In addition, all devices also have a SHUTDOWN input which disables the error amplifier and regulator output(s).

Basic Circuit Operation

Figure 4 shows the connections for fixed 5V output positive and negative regulators. The VSET input is grounded and no external resistors are required. Figure 5 shows adjustable output operation with current limiting. The output voltage is set by R1 and R2 and the current limit threshold is set by RCL. VOUT should be connected to SENSE if current limiting is not used and the SHUTDOWN input should be grounded if not used.

Output Voltage Selection

If VSET is not connected to Ground, the output voltage is set by the equation:

$$V_{OUT} = V_{SET} \times \frac{R1 + R2}{R1}, \text{ where } V_{SET} = 1.30V$$

or, to simplify resistor selection:

$$R2 = R1 \times \left(\frac{V_{OUT}}{1.30V} - 1 \right)$$

Since the input bias current at VSET has a maximum value of 10nA, relatively large values can be used for R1 and R2 with no loss of accuracy. 1M Ω is a typical value for R1. The tolerance on VSET is guaranteed to be less than $\pm$ 30mV. This allows the output to be preset without trim pots, using only fixed resistors in most cases.

Dual Mode 5V/Programmable Micropower Voltage Regulators

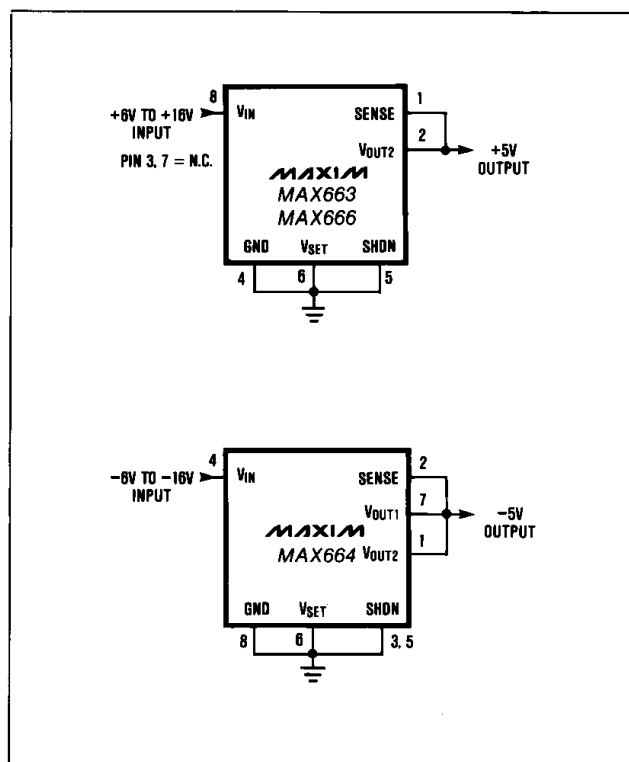


Figure 4. Connections for Fixed 5V Output

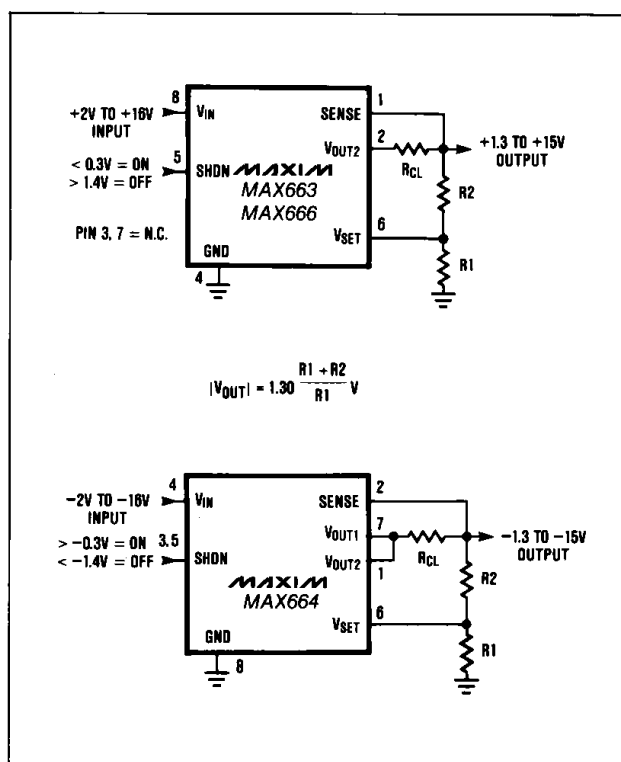


Figure 5. Connections for Adjustable Output

Current Limiting

Internal current limiting is activated on all MAX66X devices when the voltage difference between V_{OUT} and the SENSE input exceeds an internal threshold. The limit value is externally set by R_{CL} using the equation:

$$R_{CL} = \frac{V_{CL}}{I_{CL}} \quad \begin{array}{l} V_{CL} = 0.5V \text{ for MAX663 and MAX666} \\ V_{CL} = -0.6V \text{ for MAX664} \\ (V_{CL} = V_{OUT} - V_{SENSE}) \end{array}$$

where R_{CL} is the current limit sense resistor and I_{CL} is the maximum current. R_{CL} should be chosen so that neither the 50mA absolute maximum output current specification nor the maximum power dissipation is exceeded.

If current limiting is used, remember that the additional voltage drop across R_{CL} must be considered when determining the regulator's dropout voltage. If current limiting is not used, the SENSE input should be connected to the output(s).

Shutdown Input

The SHUTDOWN input allows the regulator to be turned off with a logic level signal. Since the current drain in shutdown mode is limited to the regulator's quiescent current (12μA Max) this is sometimes desirable in applications where very low power consumption is needed. The SHUTDOWN input

should be driven with a CMOS logic level since the input threshold is only 0.3V (-0.3V on the MAX664). In TTL systems, an open-collector driver with a pullup resistor will work with the MAX663/666 if a small collector current is used to keep the output's V_{SAT} below 0.3V. Collector currents as low as 1μA are suitable since the SHUTDOWN pin's input current is less than 10nA. Note that the MAX664's SHUTDOWN input is activated by a negative level. On both positive and negative regulators the SHUTDOWN input should be grounded for normal operation.

Low Battery Detection

The MAX666 contains on-chip circuitry for low battery or low power supply detection. If the voltage at LBI (Low Battery Input, pin 3) falls below the regulator's internal reference (1.30V) then LBO (Low Battery Output, pin 7), an open drain output, goes low. The threshold can be set to any level above the reference voltage by connecting a resistive divider to LBI (Figure 6) based on the equation:

$$R3 = R4 \times \left(\frac{V_{BATT}}{1.30V} - 1 \right)$$

where V_{BATT} is the desired threshold of the Low Battery Detector and $R3$ and $R4$ are the LBI input divider resistors. Since LBI's input current is no more than 10nA, then $R3$ and $R4$ can have high

MAX663/MAX664/MAX666



Temperature-Proportional Output

Negative output temperature coefficients are most commonly used in multiplexed LCD modules or display systems to compensate for the inherent negative tempco of the LCD threshold. Figure 8 shows a MAX663 generating a temperature compensated V_{DISP} for the Maxim ICM7233 triplexed LCD display driver.

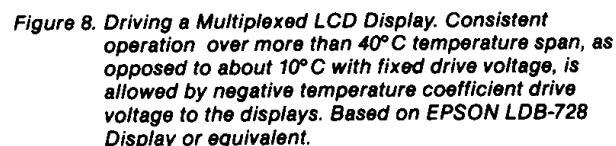
Input-Output (Dropout) Voltage

For low current applications ($I_{OUT} < 5mA$) the MAX663 can operate with input-output differentials below 1V when V_{OUT1} is used. The dropout voltage will then depend on the P-channel output FET's saturation resistance multiplied by the load current (see MAX663 Electrical Specifications, R_{SAT}).



Output Connections

When using V_{OUT1} on the MAX663 for low current, low dropout applications, V_{OUT2} and V_{OUT1} must be connected together since the current limit circuitry is referenced only to V_{OUT2} (Figure 1). V_{OUT2} does not supply load current in this configuration since the base of the NPN output transistor is shorted by the output connection. For high current operation V_{OUT2} should be used alone and V_{OUT1} should be left unconnected. V_{OUT1} is not provided on the MAX666. On the MAX664, V_{OUT1} and V_{OUT2} should always be connected together for proper operation and lowest dropout voltage.



Dual Mode 5V/Programmable Micropower Voltage Regulators

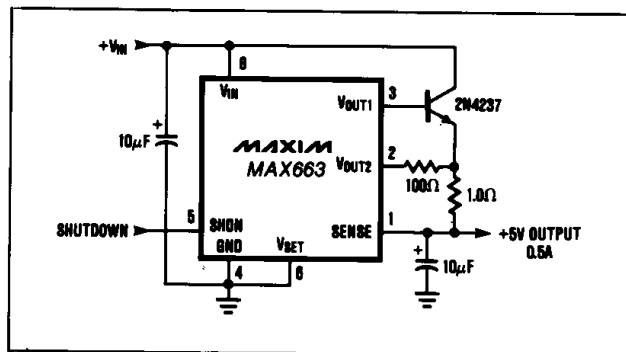


Figure 9. Positive Regulator With Boosted Output, Current Limit, and Low I_Q Shutdown

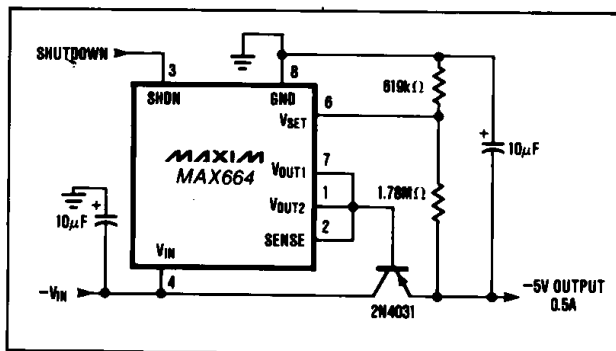


Figure 10. Negative Regulator With Boosted Output and Low I_Q Shutdown

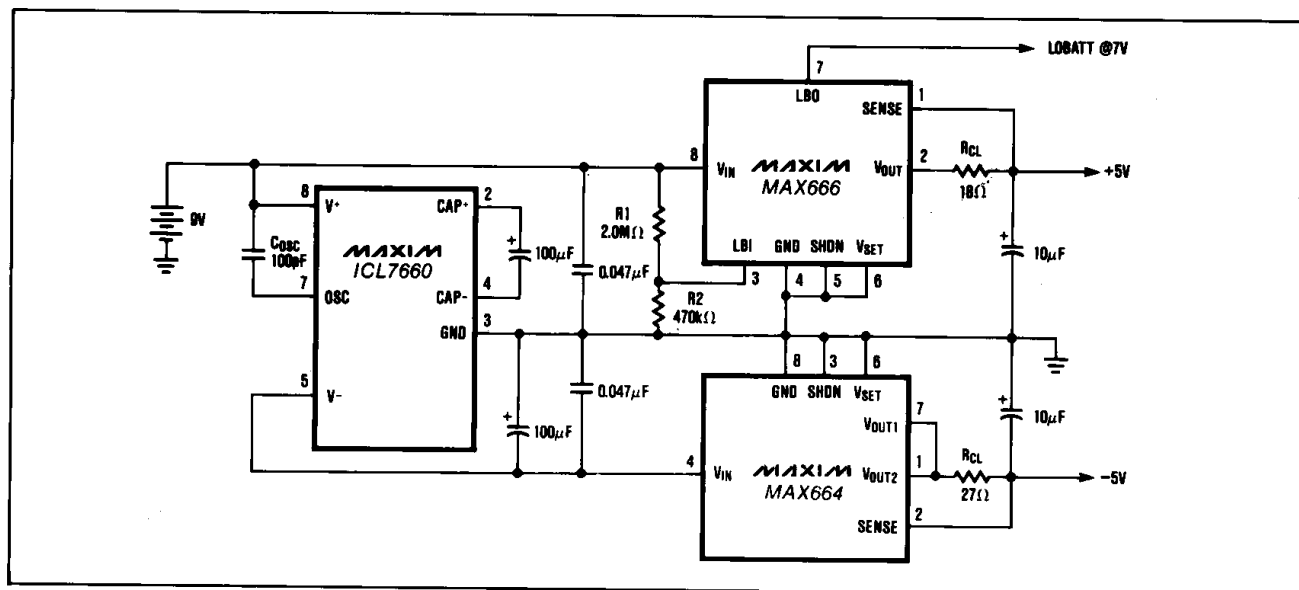


Figure 11. $\pm 5V$ Power Supply Using One 9V Battery

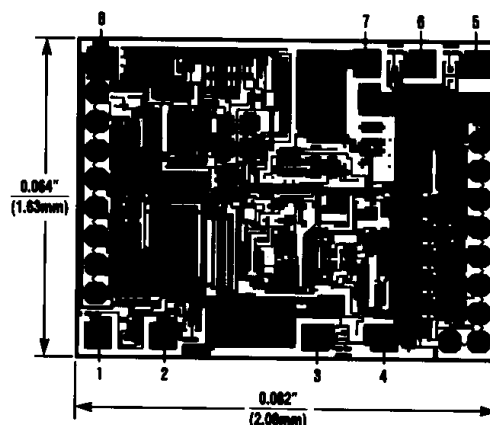
Bypass Capacitors

The MAX66X series of CMOS regulators is designed primarily for low quiescent current battery powered systems and has limited line and load regulation at frequencies above 10Hz. The high frequency performance is easily improved by adding an output filter capacitor across the load. 10 μ F is a good typical value. If high frequency performance is not an issue then an output bypass capacitor is not required.

In battery powered systems an input capacitor helps to reduce noise, improve dynamic performance, and reduce the input rate-of-rise at the regulator's input. In extreme cases excessive voltage rate-of-rise at the inputs of CMOS devices can cause SCR latch-up. The low impedance of Ni-Cad and Lead-Acid batteries make this possible when they are switched directly to the regulator input with no current limiting resistance, inductance, or input filtering. The addition of a 0.1 μ F or greater input capacitor limits the input rate-of-rise to a safe level.

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

Chip Topography



(See Pin Configurations (front page) for pin functions)